

Product Change Notice

Exar Corporation

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PRODUCTS AFFECTED:	SP3224ECY-L/TR	SP3224EEY-L/TR	SP3225ECY-L/TR	SP3225EEY-L/TR
	SP3224ECY-L	SP3224EEY-L	SP3225ECY-L	SP3225EEY-L

CHANGE CATEGORY: Material Process Package Design Datasheet Packing/Shipping Other: Alternate Assembly Site Site Site

DESCRIPTION OF CHANGE:

Qualification of an alternate assembly site, Carsem Ipoh, for the 20L TSSOP using copper or gold wire bonding.

IMPACT OF CHANGE:

There is no change to product form, fit or function.

TARGET IMPLEMENTATION DATE: 29-APRIL-2015

Please contact customer support (customersupport@exar.com) for sample date availability or qualification data

PROPRIETARY INFORMATION

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